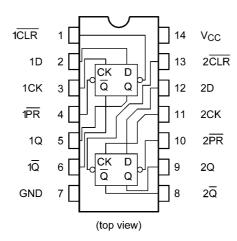
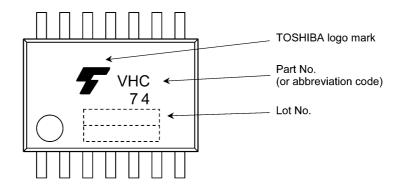


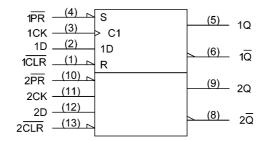
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



8. Truth Table

	Inp	outs		Out	puts	Function
CLR	PR	D	СК	Q	Q	Fullclion
L	Н	Х	Х	L	Н	Clear
Н	L	Х	Х	Н	L	Preset
L	L	Х	Х	Н	Н	_
Н	Н	L		L	Н	_
Н	Н	Н		Н	L	_
Н	Н	Х		Qn	Qn	No Change

X: Don't care



9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to 7.0	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		-20	mA
Output diode current	I _{OK}		±20	mA
Output current	I _{OUT}		±25	mA
V _{CC} /ground current	I _{CC}		±50	mA
Power dissipation	P _D	(Note 1)	180	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 180 mW in the range of T_a = -40 to 85 °C. From T_a = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

10. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V _{CC}		2.0 to 5.5	V
Input voltage	V _{IN}		0 to 5.5	V
Output voltage	V _{OUT}		0 to V _{CC}	V
Operating temperature	T _{opr}		-40 to 125	°C
Input rise and fall times	dt/dv	V_{CC} = 3.3 ± 0.3 V	0 to 100	ns/V
		V_{CC} = 5.0 ± 0.5 V	0 to 20	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	_	
Low-level input voltage	V _{IL}	_		2.0	_	_	0.50	V
				3.0 to 5.5	_	_	V _{CC} × 0.3	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	2.0	_	V
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I _{OH} = -4 mA	3.0	2.58	_	_	
			I _{OH} = -8 mA	4.5	3.94	_	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.0	0.1	V
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I _{OL} = 4 mA	3.0	_	_	0.36	
			I _{OL} = 8 mA	4.5			0.36	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_		±0.1	μΑ
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		5.5	_	_	2.0	

11.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Cond	dition	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				3.0 to 5.5	_	$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	_	V
				3.0	2.9	_	
				4.5	4.4	_	
			$I_{OH} = -4 \text{ mA}$	3.0	2.48	_	
			I_{OH} = -8 mA	4.5	3.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.1	V
				3.0	_	0.1	
				4.5	_	0.1	
			I _{OL} = 4 mA	3.0	_	0.44	
			I_{OL} = 8 mA	4.5	_	0.44	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5		±1.0	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	20.0	



11.3. DC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Cond	dition	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				3.0 to 5.5	_	$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	_	V
				3.0	2.9	_	
				4.5	4.4	_	
			$I_{OH} = -4 \text{ mA}$	3.0	2.40	_	
			$I_{OH} = -8 \text{ mA}$	4.5	3.70	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.1	٧
				3.0	_	0.1	
				4.5	_	0.1	
			I _{OL} = 4 mA	3.0	_	0.55	
			I _{OL} = 8 mA	4.5		0.55	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_	±2.0	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5		40.0	μА

11.4. Timing Requirements (Unless otherwise specified, $T_a = 25^{\circ}\text{C}$, Input: $t_f = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$ —		3.3 ± 0.3	6.0	ns
(CK)			5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}	_	3.3 ± 0.3	6.0	ns
(CLR,PR)			5.0 ± 0.5	5.0	
Minimum setup time	t _S	_	3.3 ± 0.3	6.0	ns
			5.0 ± 0.5	5.0	
Minimum hold time	t _h	_	3.3 ± 0.3	0.5	ns
			5.0 ± 0.5	0.5	
linimum removal time	t _{rem}	_	3.3 ± 0.3	5.0	ns
(CLR,PR)			5.0 ± 0.5	3.0	

11.5. Timing Requirements (Unless otherwise specified, T_a = -40 to 85°C, Input: t_f = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	_	3.3 ± 0.3	7.0	ns
(CK)			5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}	_	3.3 ± 0.3	7.0	ns
(CLR,PR)			5.0 ± 0.5	5.0	
Minimum setup time	t _S	_	3.3 ± 0.3	7.0	ns
			5.0 ± 0.5	5.0	
Minimum hold time	t _h	_	3.3 ± 0.3	0.5	ns
			5.0 ± 0.5	0.5	
Minimum removal time	t _{rem}	_	3.3 ± 0.3	5.0	ns
(CLR,PR)			5.0 ± 0.5	3.0	



11.6. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 125 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{W(L)}, t_{W(H)}$ —		3.3 ± 0.3	7.0	ns
(CK)			5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}		3.3 ± 0.3	7.0	ns
(CLR,PR)			5.0 ± 0.5	5.0	
Minimum setup time	t _S	_	3.3 ± 0.3	8.0	ns
			5.0 ± 0.5	5.5	
Minimum hold time	t _h	_	3.3 ± 0.3	0.5	ns
			5.0 ± 0.5	0.5	
Minimum removal time	t _{rem}	_	3.3 ± 0.3	5.0	ns
(CLR,PR)			5.0 ± 0.5	3.0	

11.7. AC Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	_{LH} ,t _{PHL}	_	3.3 ± 0.3	15	_	6.7	11.9	ns
(CK-Q,Q)					50	_	9.2	15.4	
				5.0 ± 0.5	15	_	4.6	7.3	
					50	_	6.1	9.3	
Propagation delay time (CLR,PR,-Q,Q)	t _{PLH} ,t _{PHL}		_	3.3 ± 0.3	15	_	7.6	12.3	ns
					50	_	10.1	15.8	
				5.0 ± 0.5	15	_	4.8	7.7	
					50	_	6.3	9.7	
Maximum clock frequency	f _{MAX}		_	3.3 ± 0.3	15	80	125	_	MHz
					50	50	75	_	
				5.0 ± 0.5	15	130	170	_	
					50	90	115	_	
Input capacitance	C _{IN}		_			_	4	10	pF
Power dissipation capacitance	C _{PD}	(Note 1)	_			_	25		pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/2 \text{ (per F/F)}$



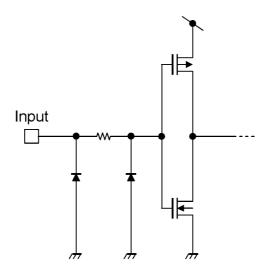
11.8. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_f = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	_	3.3 ± 0.3	15	1.0	14.0	ns
(CK-Q,Q)				50	1.0	17.5	
			5.0 ± 0.5	15	1.0	8.5	
				50	1.0	10.5	
Propagation delay time (CLR,PR-Q,Q)	t _{PLH} ,t _{PHL}	_	3.3 ± 0.3	15	1.0	14.5	ns
				50	1.0	18.0	
			5.0 ± 0.5	15	1.0	9.0	
				50	1.0	11.0	
Maximum clock frequency	f _{MAX}	_	3.3 ± 0.3	15	70	_	MHz
				50	45	_] [
			5.0 ± 0.5	15	110	_	
				50	75		
Input capacitance	C _{IN}				_	10	pF

11.9. AC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	_	3.3 ± 0.3	15	1.0	16.0	ns
(CK-Q,Q)				50	1.0	19.5	
			5.0 ± 0.5	15	1.0	10.0	
				50	1.0	12.0	
Propagation delay time (CLR,PR-Q,Q)	t _{PLH} ,t _{PHL}	_	3.3 ± 0.3	15	1.0	16.5	ns
				50	1.0	20.0	
			5.0 ± 0.5	15	1.0	10.5	
				50	1.0	12.5	
Maximum clock frequency	f _{MAX}	_	3.3 ± 0.3	15	60	_	MHz
				50	40	_	
			5.0 ± 0.5	15	100	_	
				50	70	_	
Input capacitance	C _{IN}	_			_	10	pF

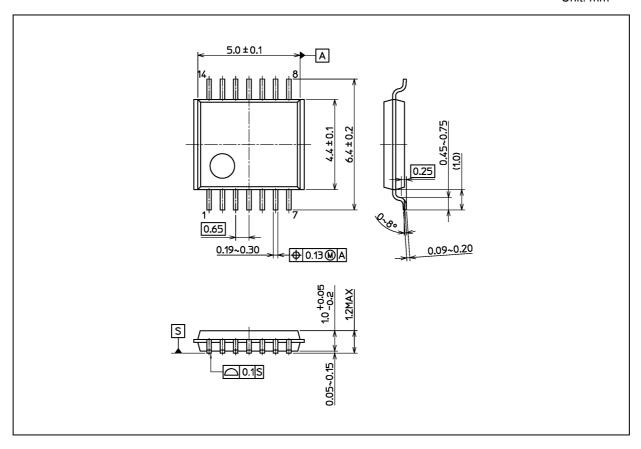
12. Input Equivalent Circuit





Package Dimensions

Unit: mm



Weight: 0.054 g (typ.)

	Package Name(s)
Nickname: TSSOP14B	



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